LM8V311

Passive Matrix Color LCD Module

(640 × 480 Dots)

(Spec. No.: LC98312)

Spec. Issue Date: March 30, 1998

SHARP

LIQUID CRYSTAL DISPLAY GROUP
SHARP CORPORATION

SPECIFICATION

DEVICE SPECIFICATION for
Passive Matrix Color LCD Module
(640 × 480 dots)

Model No.

LM8V311

☐CUSTOMER'S APPROVAL

DATE _____

BY _____

PRESENTED
BY _____
Y. Inoue
DIVISION GENERAL MANAGER
DUTY LCD DEVELOPMENT CENTER
NARA LIQUID CRYSTAL DISPLAY GROUP
SHARP CORPORATION

SHARP

RECORDS OF REVISION				DOC.FIRST ISSUE MAR.30.1998
DATE	REF.PAGE PARAGRAPH DRAWING No.	REVISED NO.	SUMMARY	CHECK AND APPROVAL

○Precautions

1) Industrial(Mechanical) design of the product in which this LCD module will be incorporated must be made so that the viewing angle characteristics of the LCD may be optimized.
This module's viewing angle is illustrated in Fig.1.

θ y MIN. < viewing angle < θ y MAX.

(For the specific values of θ y MIN., and θ y MAX., refer to the table)

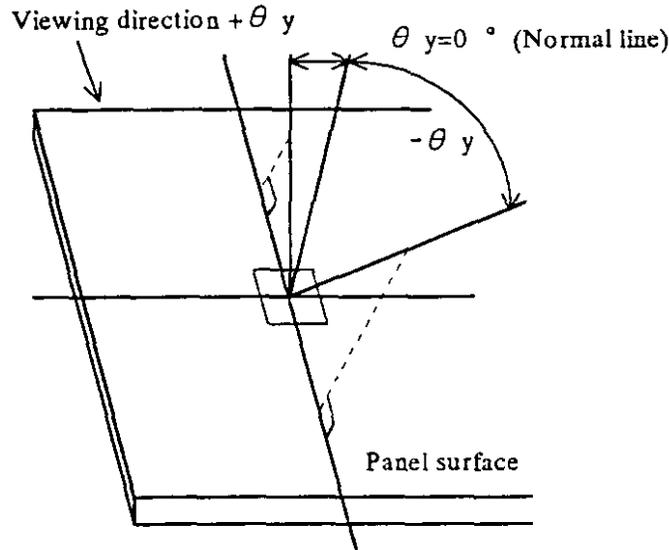Please consider the optimum viewing conditions according to the purpose when installing the module.

Fig.1 Definition of viewing angle

2) This module should be installed using mounting holes of metal bezel.
When installing the module, pay attention and handle carefully not to allow any undue stress such as twist or bend.

3) Since the front polarizer is easily damaged. Please pay attention not to scratch on its face.
It is recommended to use a transparent acrylic resin board or other type of protective panel on the surface of the LCD module to protect the polarizer, LCD panel, etc..

4) If the surface of the LCD panel is required to be cleaned, wipe it swiftly with cotton or other soft cloth. If it is not still clear completely, blow on and wipe it.

5) Water droplets, etc. must be wiped off immediately since they may cause color changes, staining, etc., if it remained for a long time.

6) Since LCD is made of glass substrate, dropping the module or banging it against hard objects may cause cracking or fragmentation.

7) Since CMOS LSIs are equipped in this module, following countermeasures must be taken to avoid electrostatics charge.

1. Operator

Electrostatic shielding clothes shall be had because it is feared that the static electricity is electrified to human body in case that operator have a insulating garment.

2. Equipment

There is a possibility that the static electricity is charged to equipment which have a function of peeling or mechanism of friction(EX: Conveyer, soldering iron, working table), so the countermeasure countermeasure(electrostaticearth:$1 \times 10^8 \ \Omega$) should be made.

3. Floor

Floor is a important part to leak static electricity which is generated from human body or equipment. There is a possibility that the static electricity is charged to them without leakage in case of insulating floor, so the countermeasure(electrostatic earth:$1 \times 10^8 \ \Omega$) should be made.

4. Humidity

Humidity of working room may lower electrostatics generating material's resistance and have something to prevent electrifying. So, humidity should be kept over 50% because humidity less than 50 % may increase material's electrostatic earth resistance and it become easy to electrify.

5. Transportation/storage

The measure should be made for storage materials because there is a possibility that the static electricity, which electrify to human body or storage materials like container by friction or peeling, cause the dielectric charge.

6. Others

The laminator is attached on the surface of LCD module to prevent from scratches, fouling and dust. It should be peeled off unhurriedly with using static eliminator.

And also, static eliminator should be installed to prevent LCD module from electrifying at assembling line.

8) Don't use any materials which emit gas from epoxy resin(amines' hardener) and silicon adhesive agent(dealcohol or deoxym) to prevent change polorizer color owing to gas.

9) Since leakage current, which may be caused by routing of CCFT cables, etc., may affect the brightness of display, the inverter has to be designed taking the leakage current into consideration. Thorough evaluation of the LCD module/inverter built into its host equipment shall be conducted, therefore, to ensure the specified brightness.

10) Avoid to expose the module to the direct sun-light, strong ultraviolet light, etc. for a long time.

11) If stored at temperatures under specified storage temperature, the LC may freeze and be deteriorated. If storage temperature exceed the specified rating, the molecular orientation of the LC may change to that of a liquid, and they may not revert to their original state. Therefore, the module should be always stored at normal room temperature.

12) Disassembling the LCD module can cause permanent damage and should be strictly avoided.

13) Procedure insert mating connector

When the mating connector is inserted, it should be parallel to the used connector of LCD module and it should be inserted horizontally.

When the mating connector is attempted to be fixed to LCD connector, it should be inserted properly in order not to create a gap as shown "A".

Please insert the connector as both edge is placed to the connect position of LCD connector.

LCD Connector

Parallel   LCD Connector   LCD Connector

A
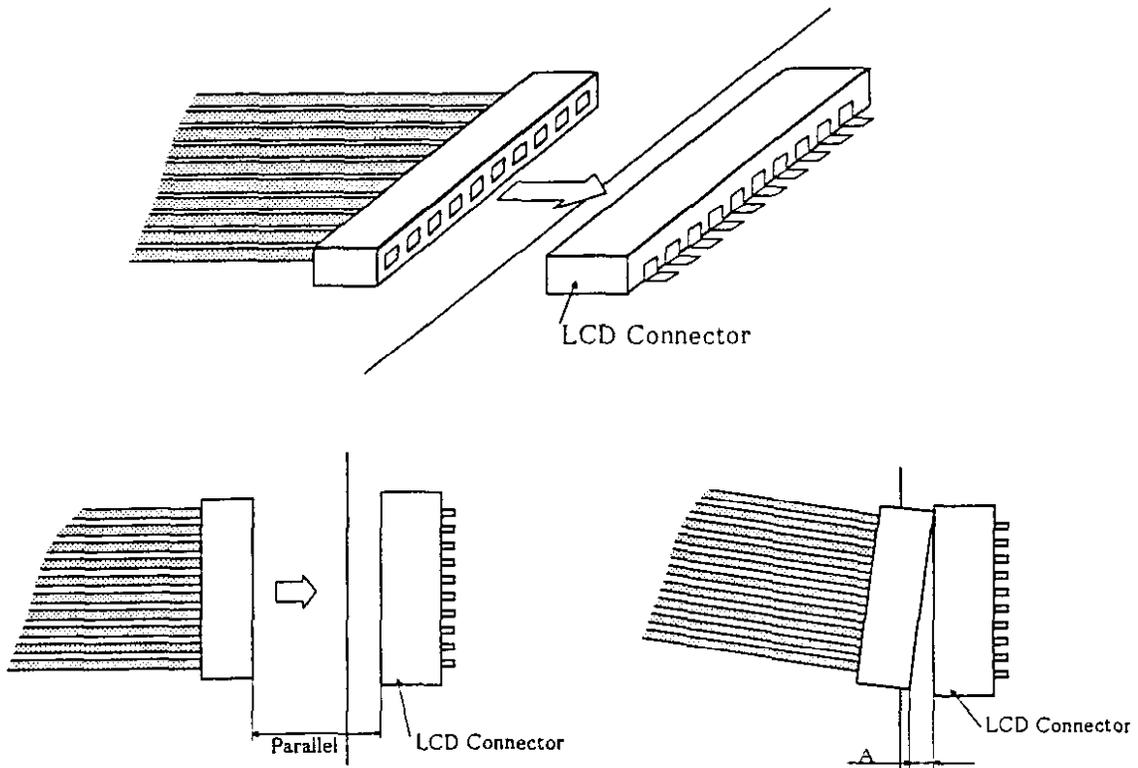
14) This specification describes display quality in case of no gray scale. Since display quality can be affected by gray scale methods, display quality shall be carefully evaluated for the usability of LCD module in case gray scale is displayed on the LCD module.

15) The module should be driven according to the specified ratings to avoid permanent damage.

DC voltage drive leads to rapid deterioration of LC, so ensure that the drive is alternating waveform by continuous application of the signal M. Especially the power ON/OFF sequence shown on Page 25 should be kept to avoid latch-up of drive LSIs and application of DC voltage to LCD panel.

○Contents

1.Application

This data sheet is to introduce the specification of LM8V311, passive Matrix type Color LCD module.

2.Construction and Outline

Construction: 640 × 480 dots color display module consisting of an LCD panel, PWB(printed wiring board) with electric components mounted onto, TCP(tape carrier package) to connect the LCD panel and PWB electrically, and plastic chassis with CCFT back light and bezel to fix them mechanically.
Signal ground(Vss) is connected with the metal bezel.
DC/DC converter is built in.
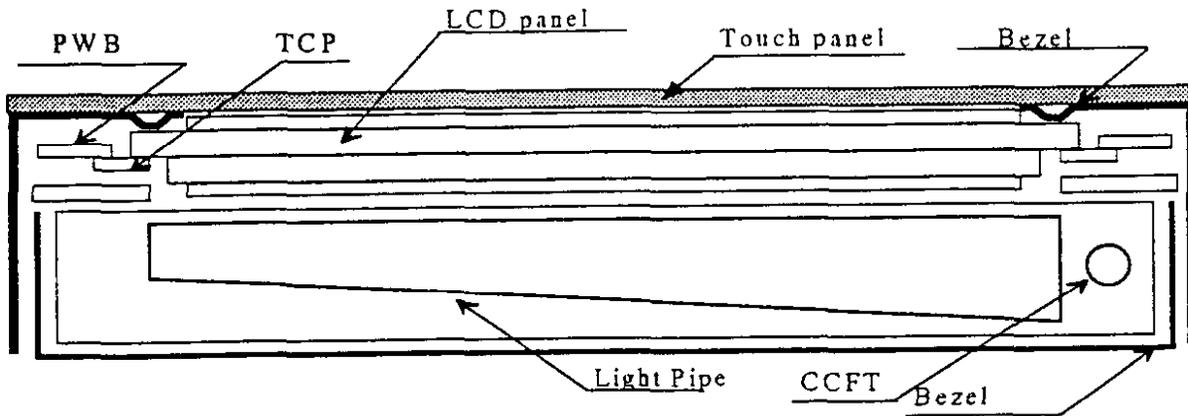
Outline   :See Fig. 14
Connection   :See Fig. 14 and Table 6

3.Mechanical Specification

Table1

Parameter	Specifications	Unit
Outline dimensions	197(W)×142.5(H)×9.5MAX(D)	mm
Active area	157.42(W)×118.06(H)	mm
Display format	640(W)×480(H)	mm
Dot size	0.062×RGB(W)×0.226(H)	-
Dot spacing	0.02	mm
*1 Base color	Normally black *2	-
Weight	Approx.310	g

*1 Due to the characteristics of the LC material, the colors vary with environmental temperature.

*2 Negative-type display

    Display data "H" : ON → transmission

    Display data "L" : OFF → light isolation

4.Absolute Maximum Ratings

 4-1.Electrical absolute maximum ratings

Table 2

Parameter	Symbol	MIN.	MAX.	Unit	Remark
Supply voltage(Logic)	V_{DD}-V_{SS}	0	6.0	V	Ta=25 ℃
Input voltage	V_{IN}	-0.3	V_{DD}+0.3	V	Ta=25 ℃
Vcon voltage	Vcon	0	V_{DD}	V	Ta=25 ℃

4-2.Environment Conditions

Table 3

Item	Tstg		Topr		Remark
	MIN.	MAX.	MIN.	MAX.	
Ambient temperature	-25 ℃	+60 ℃	0 ℃	+40℃	Note 4)
Humidity	Note 1)		Note 1)		No condensation
Vibration	Note 2)		Note 2)		3 directions(X/Y/Z)
Shock	Note 3)		Note 3)		6 directions(±X±Y±Z)

Note 1) Ta$\leqq$40 ℃.......95 % RH Max.

Ta＞40 ℃.......Absolute humidity shall be less than Ta=40 ℃/95 % RH.

Note 2)

Table 4

Frequency	10 Hz～57 Hz	57 Hz～500 Hz
Vibration level	-	9.8 m/s^2
Vibration width	0.075 mm	-
Interval	10 Hz～500 Hz～10 Hz/11.0 min	

2 hours for each direction of X/Y/Z (6 hours as total)

Note 3) Acceleration : 490 m/s^2
Pulse width : 11 ms
3 times for each directions of ±X/±Y/±Z

Note 4) Care should be taken so that the LCD module may not be subjected to the temperature out of this specification.

SHARP

5.Electrical Specifications

5-1.Electrical characteristics

<u>Table 5</u>   Ta=25 ℃   VDD= 3.3 V $\pm$ 10 %   1/tFRM=75 Hz

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
Supply voltage (Logic)	V_{DD}-V_{SS}	Ta = 0～40 ℃ (Note 1)		3.0	3.3	3.6	V
Contrast adjust voltage (Note 4)	Vcon-V_{SS}	Ta = 0 ℃～40℃		0.8	1.95	2.8	V
Input signal voltage	V_{IN}	"H" level	Ta = 0～	$0.8V_{DD}$	-	V_{DD}	V
		"L" level	40 ℃	0	-	$0.2V_{DD}$	V
Supply current	I_{DD}1(TYP.)	Ta =25 ℃(Note 1,2)		-	40	60	mA
	I_{DD}2(MAX.)	Ta=25 ℃(Note1,3)		-	50	75	mA
Rush current (Logic)	Irush	Ta =25 ℃ (Note 1)		0.6A×10ms			
Ripple current (Logic)	Irip	Ta =25 ℃ (Note 1)		0.15A×100 μ S			
Power consumption	Pd1(TYP)	Note 2)		-	130	200	mW
	Pd2(MAX)	Note 3)		-	165	250	mW

Note 1) Under the following conditions.;

    ① Immediately after the rise of V_{DD} .   : 0.6A×10ms

    ② Under the situation that DISP signal is on and kept steady   : 0.15A×100 μ S

Note 2) Frame frequency = 75 Hz, Vcon - Vss =max contrast voltage

    Display pattern = all digits ON (DU0-7,DL0-7 = "H")
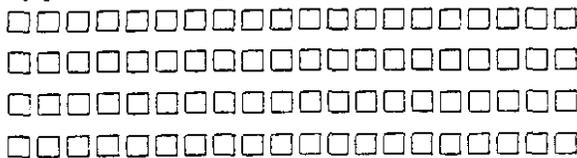
Note 3) Frame frequency = 75 Hz, Vcon - Vss = max contrast voltage

    Display pattern = black/white stripe pattern
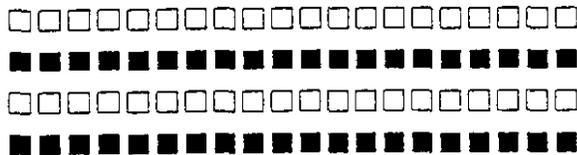
Note 4) Contrast adjust voltage "Vcon-Vss" is transformed into the LCD driving voltage "V_{LCD}" by following circuit built in the LCD module.

LCD driving voltage "V_{LCD}" is adjusted automatically according to the change of ambient temperature range by the temperature compensation circuit.

Temperature compensation circuit built in LCD module have been set obtain the optimum contrast under following driving conditions.;

Take care that voltage for optimum contrast is changed under the different condition.

Frame frequency : 75 Hz,　Duty ratio : 1/244 (an odd number frame), Ta = 25 ℃

※The above is the condition of the module setting, not the electrical characteristics.
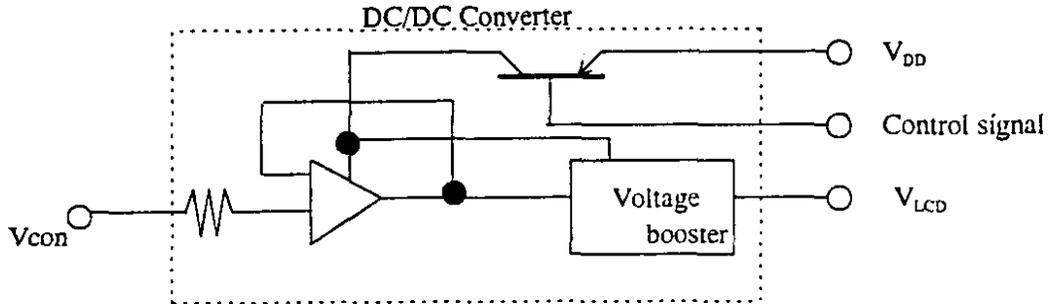
5-2. Interface signals

○CN1

<div align="center">Table 6-1</div>

Pin No.	Symbol	Description	Level
1	YD	Scan start-up signal	"H"
2	VSS	Ground potential	-
3	DISP	Display control signal	H(ON), L(OFF)
4	LP	Input data latch signal	"H" → "L"
5	VSS	Ground potential	-
6	XCK	Shift clock for input data	"H" → "L"
7	VSS	Ground potential	-
8	DU0	Display data signal (Upper)	H(ON), L(OFF)
9	DU1	Display data signal (Upper)	H(ON), L(OFF)
10	DU2	Display data signal (Upper)	H(ON), L(OFF)
11	DU3	Display data signal (Upper)	H(ON), L(OFF)
12	DU4	Display data signal (Upper)	H(ON), L(OFF)
13	DU5	Display data signal (Upper)	H(ON), L(OFF)
14	DU6	Display data signal (Upper)	H(ON), L(OFF)
15	DU7	Display data signal (Upper)	H(ON), L(OFF)

○CN2

<div align="center">Table 6-2</div>

Pin No.	Symbol	Description	Level
1	DL0	Display data signal (Lower)	H(ON), L(OFF)
2	DL1	Display data signal (Lower)	H(ON), L(OFF)
3	DL2	Display data signal (Lower)	H(ON), L(OFF)
4	DL3	Display data signal (Lower)	H(ON), L(OFF)
5	DL4	Display data signal (Lower)	H(ON), L(OFF)
6	DL5	Display data signal (Lower)	H(ON), L(OFF)
7	DL6	Display data signal (Lower)	H(ON), L(OFF)
8	DL7	Display data signal (Lower)	H(ON), L(OFF)
9	VDD	Power supply for logic(3.3v)	-
10	VSS	Ground potential	-
11	VSS	Ground potential	-
12	NC	-	-
13	NC	-	-
14	Vcon	Contrast adjustment voltage	-

○CCFT   Table6-3

Pin No	Symbol	Description	Level
1	GND	Ground line (from Inverter)	-
2	NC	NC	-
3	HV	High voltage line (from Inverter)	-

5-3.Connectors

   ○LCD
        Used connector   : CN1 53261-1510(Molex)   CN2 53261-1410(Molex)
        Correspondable connector : CN1 51021-1500(Molex)   CN2 51021-1400(Molex)
   ○CCFT
        Used connector   :QZ-19-3F01(Honda Tsushin kogyo)
        Correspondable connector :QZ-19-A3MYL#02(Honda Tsushin kogyo)

        Except above connector shall be out of guaranty.

Fig.2 Dot chart of display area

COLUMN

ROW

640 × 3 (RGB)
× 480 dots

(1,1) (1,2) ... (1,639) (1,640)
(2,1) (2,2) ... (2,639) (2,640)
(479,1) (479,2) ... (479,639) (479,640)
(480,1) (480,2) ... (480,639) (480,640)
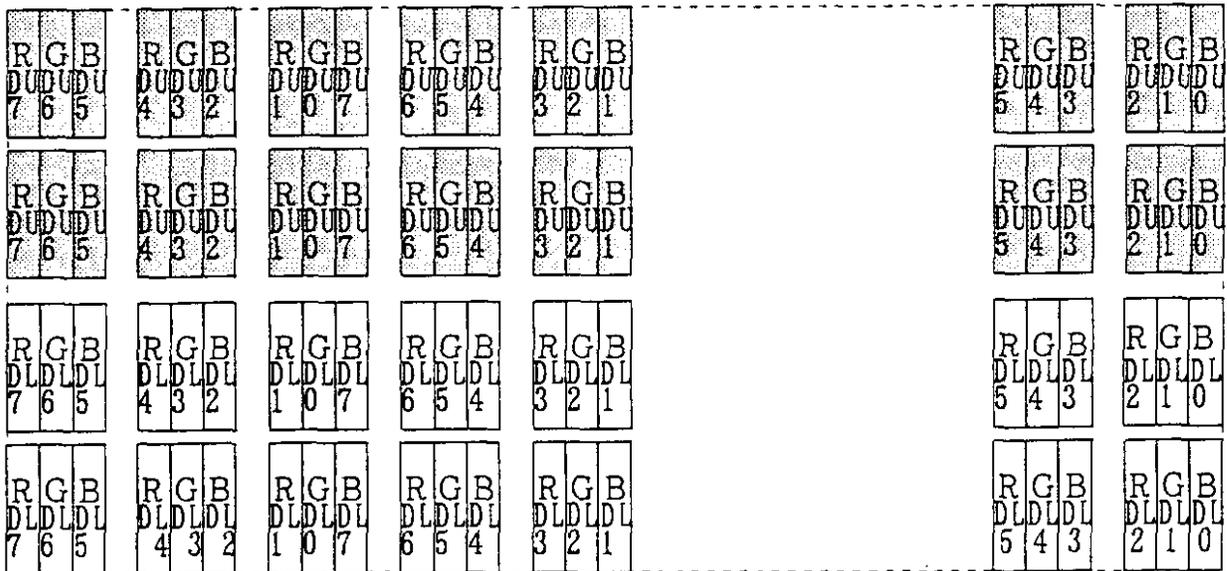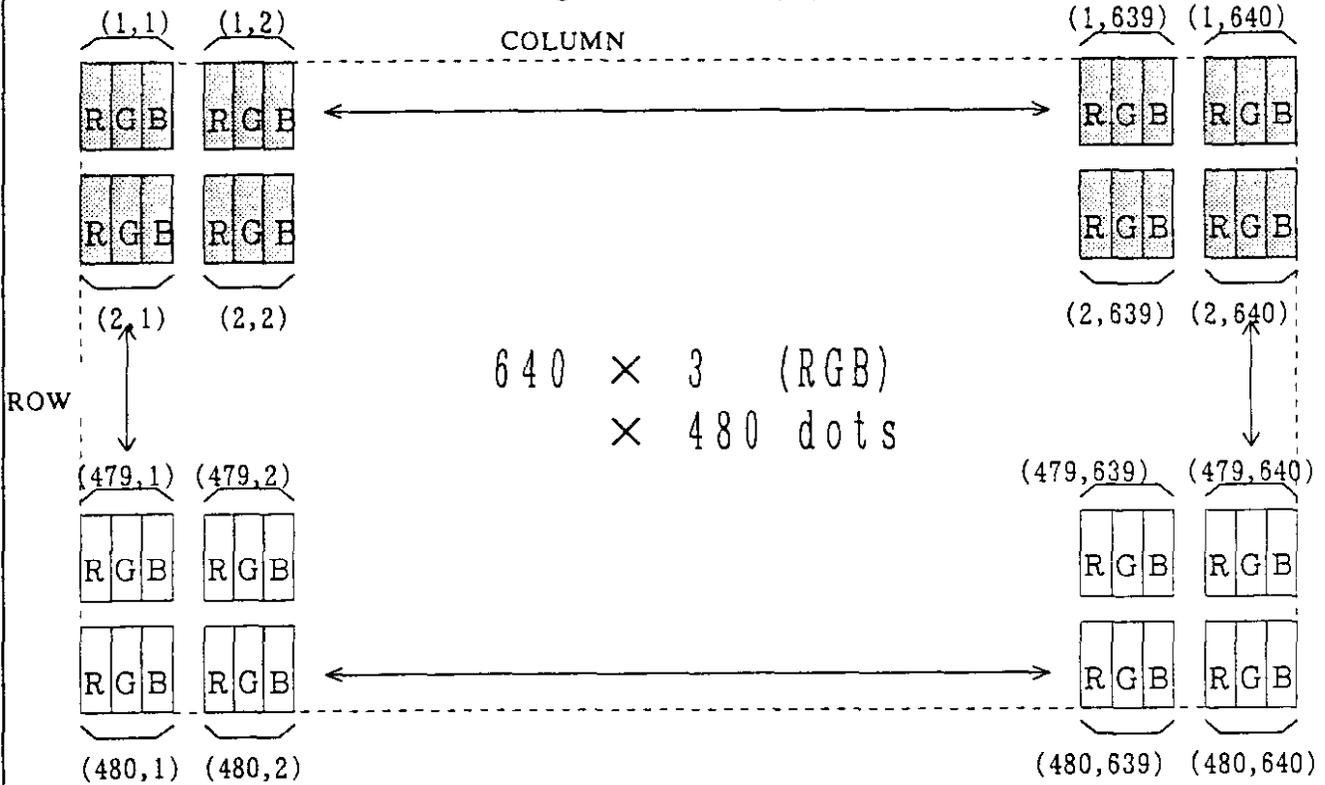
Upper SEG Drevers , Upper data(DU0-7)

Lower SEG Drivers ,Lower data(DL0-7)

LP × 244 pulses

YD

LP

DU0
~
DU7

| 1st line's display data | 2nd line's display data | // | 244th line's display data | 1st line's display data | 2nd line's display data |

DL0
~
DL7

| 241th line's display data | 242th line's display data | // | 484th line's display data | 241th line's display data | 242th line's display data |

XCK × 640 × (3/8) pulses

LP

XCK

XCK

DU7	R(1,1)	B(1,3)	G(1,6)		R(1,9)	B(1,11)	G(1,14)
DU6	G(1,1)	R(1,4)	B(1,6)		G(1,9)	R(1,12)	B(1,14)
DU5	B(1,1)	G(1,4)	R(1,7)		B(1,9)	G(1,12)	R(1,15)
DU4	R(1,2)	B(1,4)	G(1,7)		R(1,10)	B(1,12)	G(1,15)
DU3	G(1,2)	R(1,5)	B(1,7)		G(1,10)	R(1,13)	B(1,15)
DU2	B(1,2)	G(1,5)	R(1,8)		B(1,10)	G(1,13)	R(1,16)
DU1	R(1,3)	B(1,5)	G(1,8)		R(1,11)	B(1,13)	G(1,16)
DU0	G(1,3)	R(1,6)	B(1,8)		G(1,11)	R(1,14)	B(1,16)

DL7	R(241,1)	B(241,3)	G(241,6)		R(241,9)	B(241,11)	G(241,14)
DL6	G(241,1)	R(241,4)	B(241,6)		G(241,9)	R(241,12)	B(241,14)
DL5	B(241,1)	G(241,4)	R(241,7)		B(241,9)	G(241,12)	R(241,15)
DL4	R(241,2)	B(241,4)	G(241,7)		R(241,10)	B(241,12)	G(241,15)
DL3	G(241,2)	R(241,5)	B(241,7)		G(241,10)	R(241,13)	B(241,15)
DL2	B(241,2)	G(241,5)	R(241,8)		B(241,10)	G(241,13)	R(241,16)
DL1	R(241,3)	B(241,5)	G(241,8)		R(241,11)	B(241,13)	G(241,16)
DL0	G(241,3)	R(241,6)	B(241,8)		G(241,11)	R(241,14)	B(241,16)

* Electrical and optical characteristics are specified by above condition.

Fig. 3   Data input timing chart

t_{FRM}

t_{HYH}

t_{HYS}

t_{LYS}

t_{LYH}

YD

t_{WLPH}

LP

LP

t_{CK}

t_r

t_f

t_{WCKH} t_{WCKL}

t_{LS}

t_{LH}

XCK

t_{DH}

t_{DS}
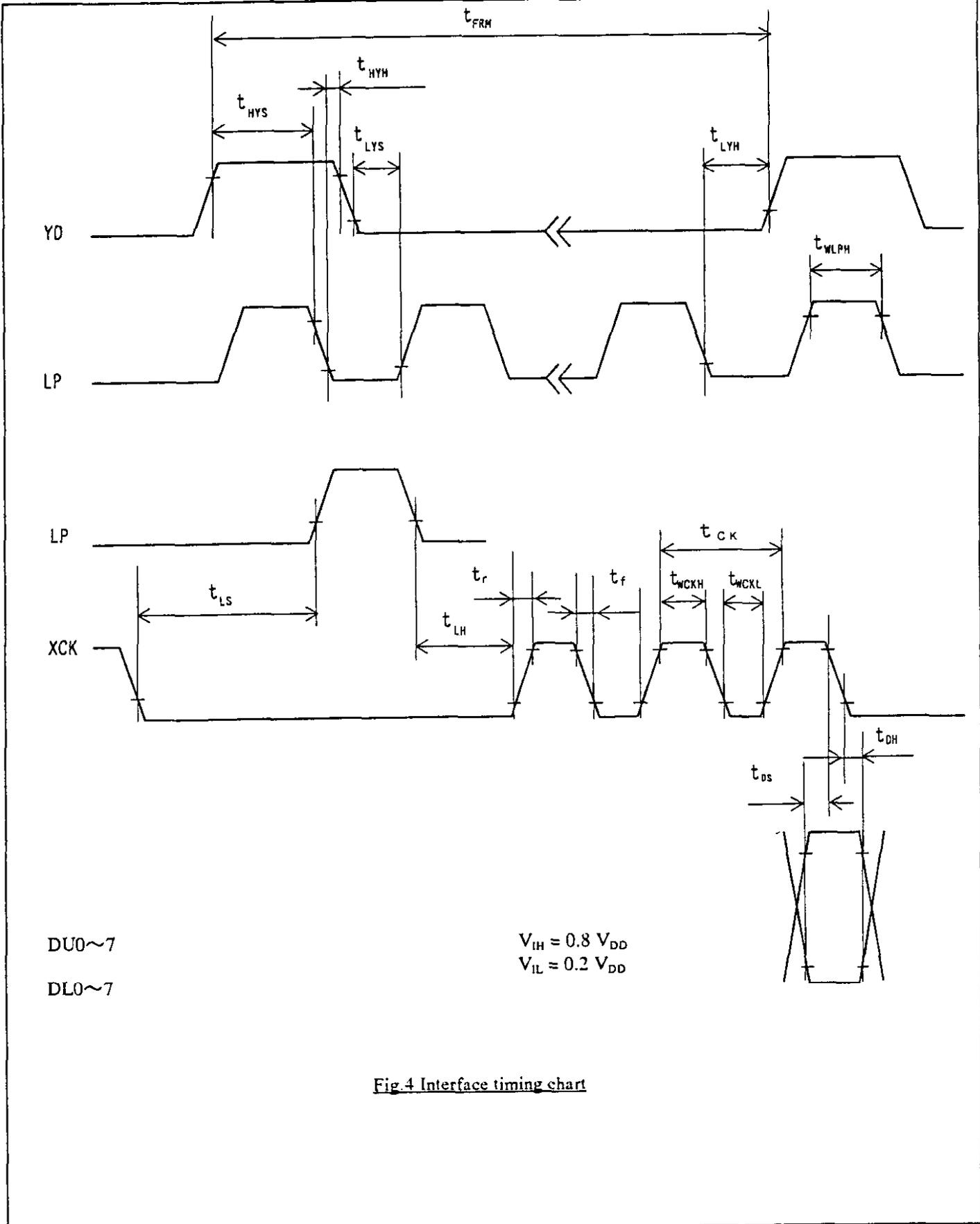
DU0~7

DL0~7

$V_{IH} = 0.8\ V_{DD}$
$V_{IL} = 0.2\ V_{DD}$

Fig.4 Interface timing chart

Table 7 Interface timing ratings

Ta=25 °C,VDD=3.3 V±10 %

Item	Symbol	Rating			Unit
		MIN.	TYP.	MAX.	
Frame cycle *2	t_{FRM}	8.33		16.94	ms
XCK signal clock cycle	t_{CK}	55			ns
"H" level clock width	t_{WCKH}	20			ns
"L" level clock width	t_{WCKL}	20			ns
LP signal "H" level pulse width	t_{WLPH}	250			ns
Data set up time	t_{DS}	17			ns
hold time	t_{DH}	23			ns
YD signal "H" level set up time	t_{HYS}	125			ns
"H" level hold time	t_{HYH}	125			ns
"L" level set up time	t_{LYS}	100			ns
"L" level hold time	t_{LYH}	40			ns
LP ↑ allowance time from XCK ↓	t_{LS}	200			ns
XCK ↑ allowance time from LP ↓	t_{LH}	200			ns
Input signal rise/fall time *1	t_r, t_f			13	ns

*1   When LCD module is operated by high speed of XCK(Shift clock), $(t_{CK} - t_{WCKH} - t_{WCKL})/2$ is maximum.

*2   According to our experiments, frame cycle of 8.33 ms Min. or frame frequency of 120 Hz Max. will demonstrate optimum display quality in terms of flicker and "shadowing". But since judgment of display quality is subjective and display quality such as "shadowing" is pattern dependent, it is recommended that decision of frame frequency, to which power consumption of the LCD module is proportional, be made based on your own through testing on the LCD module with every possible patterns displayed on it

※   The intervals of one LP fall and next must be always the same, and LPs must be input continuously. The intervals must be 70 μ s Max.

6. Module Driving Method

6-1. Circuit configuration
Fig.10 shows the block diagram of the module's circuitry.

6-2. Display face configuration
The display consists of 640 × 3(R,G,B) × 480 dots as shown in Fig. 2.
The interface is single panel with double drive to be driven at 1/244duty ratio.

6-3. Input data and control signal
The LCD driver is 240 bits LSI, consisting of shift registers, latch circuits and LCD driver circuits. Input data for each row 640 × 3 (R,G,B) will be sequentially transferred in the form of 8 bit parallel data through shift registers from top left of the display together with clock signal (XCK).

When input of one row 640 × 3 (R,G,B) is completed, the data will be latched in the form of parallel data corresponding to the signal electrodes by the falling edge of latch signal (LP) then, the corresponding drive signals will be transmitted to the 640 × 3 lines of column electrodes of the LCD panel by the LCD drive circuits.
At this time, scan start-up signal (YD) has been transferred from the scan signal driver to the 1st row of scan electrodes, and the contents of the data signals are displayed on the 1st row of the display face according to the combinations of voltages applied to the scan and signal electrodes of the LCD. While the data of 1st row are being displayed, the data of 2nd row are entered. When data for 640 × 3 dots have been transferred, they will be latched by the falling edge of LP, switching the display to the 2nd row.

Such data input will be repeated up to the 244th row of each display segment, from upper row to lower rows, to complete one frame of display by time sharing method.

Simultaneously the same scanning sequence occur at the lower panel.
Then data input proceeds to the next display frame.

YD generates scan signal to drive horizontal electrodes.

Since DC voltage, if applied to LCD panel, causes chemical reaction in LC materials, causing deterioration of the materials, drive wave-form shall be inverted at every display frame to prevent the generation of such DC voltage.
Control signal M plays such a role.

Because of the characteristics of the CMOS driver LSI, the power consumption of the display module goes up with the clock frequency of XCK.
To minimize data transfer speed of XCK clock the LSI has the system of transferring 8 bit parallel data through the 8 lines of shift registers.
Thanks to this system the power consumption of the display module is minimized.

In this circuit configuration, 8 bit display data shall input to data input pins of DU0-7 and DL0-7.

Furthermore, the display module has bus line system for data input to minimize the power consumption with data input terminals of each driver LSI being activated only when relevant data input is fed.

SHARP

Data input for column electrodes and chip select of driver LSI are made as follows:

The driver LSI at the left end of the display face is first selected, and the adjacent driver LSI right next side is selected when data of 240 dot (30XCK) is fed. This process is sequentially continued until data is fed to the driver LSI at the right end of the display face. This process is followed simultaneously both at the top and bottom column drivers LSI's.

Thus data input will be made through 8 bit bus line sequentially from the left end of the display face.

Since this display module contains no refresh RAM, it requires the above data and timing pulse inputs even for static display.

The timing chart of input signals are shown in fig. 4 and Table 7.

7.Optical Characteristics

Following spec are based upon the electrical measuring conditions, on which the contrast of perpendicular direction(θ x = θ y = 0 °) will be MAX..

Table 8   Ta = 25 ℃, V_{DD}= 3.3V,   Vcon-V_{SS} = Vmax

Parameter		Symbol	Condition		MIN.	TYP.	MAX.	Unit	Remark
Viewing angle range		θ x	Co>5.0	θ y = 0 °	-30	-	30		Note 1)
		θ y		θ x = 0 °	-30	-	15		
Contrast ratio		Co	θ x = θ y = 0 °		-	30	-	-	Note2)
Response time	Rise	τ r	θ x = θ y = 0 °		-	270	-	ms	Note3)
	Decay	τ d	θ x = θ y = 0 °			80	-	ms	
Module chromaticity	White	x	θ x = θ y = 0 °		-	0.275	-	-	
		y	θ x = θ y = 0 °		-	0.330	-	-	

Note 1)   The viewing angle range is defined as shown Fig.5.
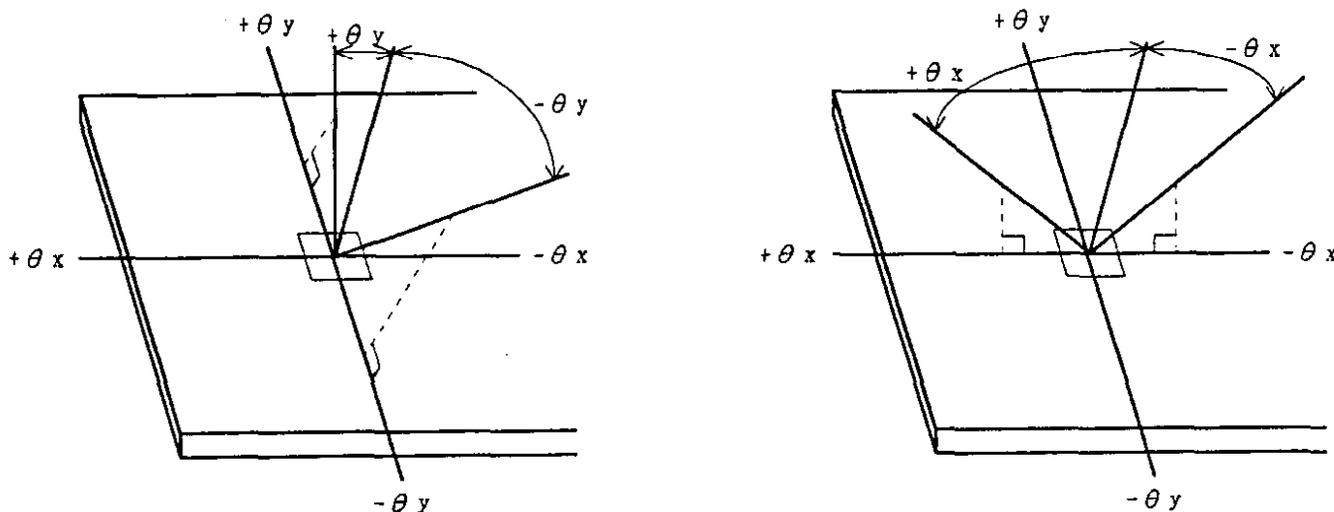
Fig.5   Definition of Viewing Angle

Note 2)   Contrast ratio is defined as follows:

$$Co = \frac{\text{Luminance(brightness) all pixes "White" at Vmax}}{\text{Luminance(brightness) all pixes "dark " at Vmax}}$$

Vmax is defined in Fig.7.

Note 3)   The response characteristics of photo-detector output are measured as shown in Fig.9, assuming that input signals are applied so as to select and deselect the dot to be measured, in the optical characteristics test method shown in Fig.8.

TOPCON BM-7

Measuring
Field: 2 °
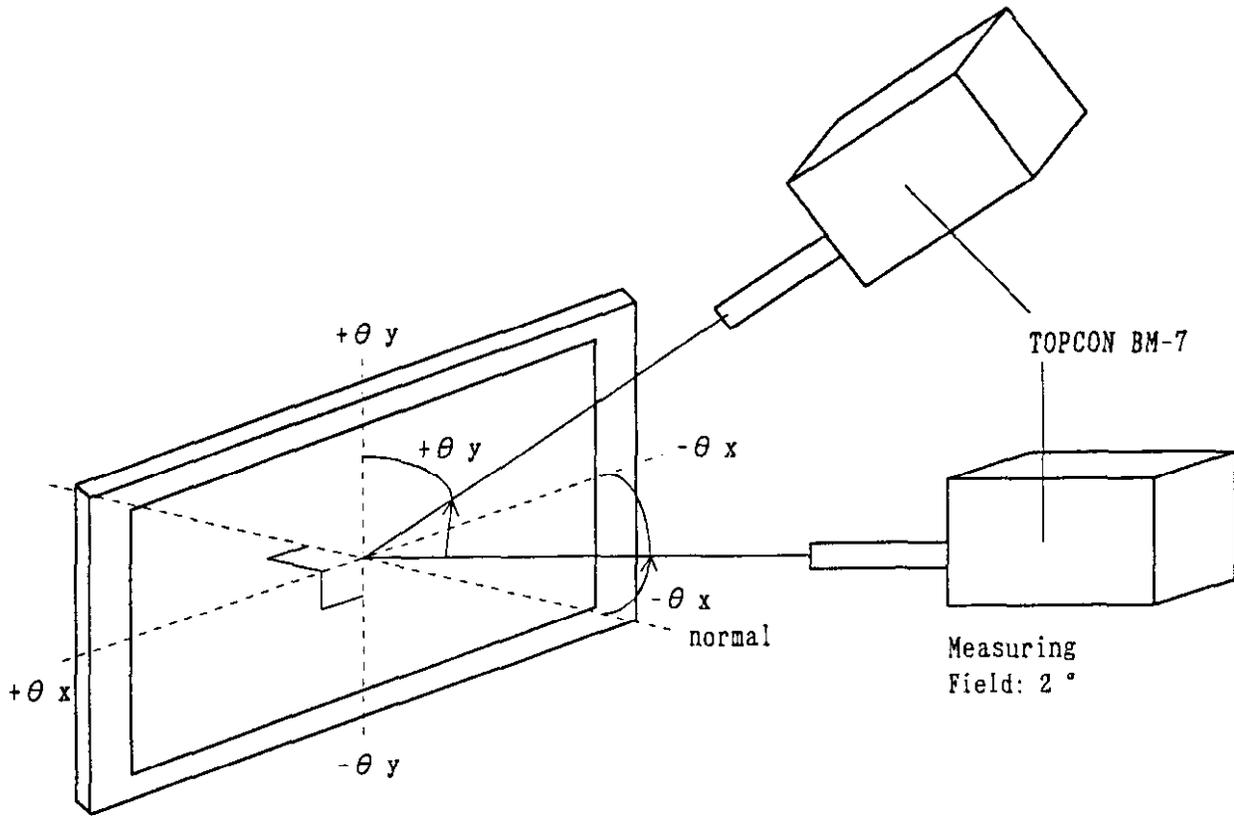
Measuring Spot Size : φ 10 mm

θ x : Angle from "normal" to viewing surface rotated about the horizontal axis.

θ y : Angle from "normal" to viewing surface rotated about the vertical axis.

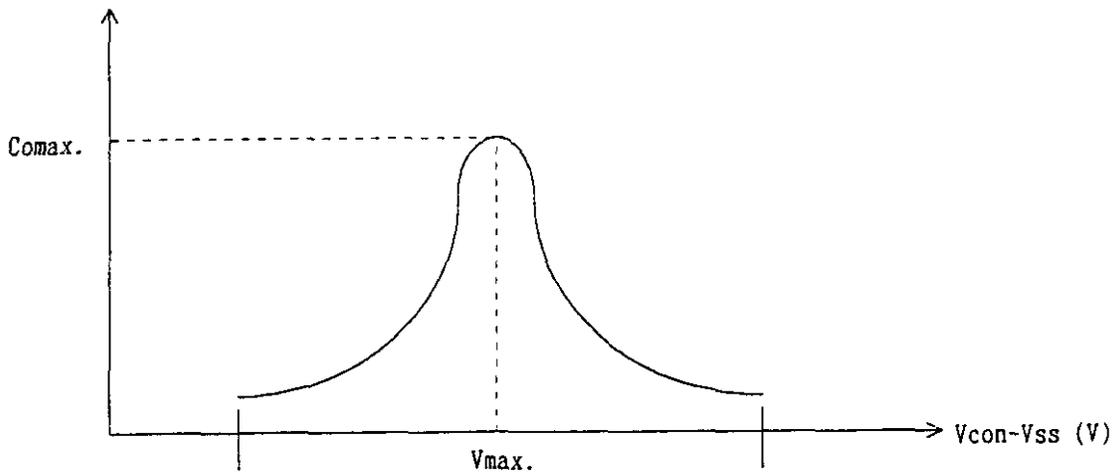Fig.6 Optical Characteristics Test Method I

Fig.7 Definition of Vmax

(Response Measurement)

Ta = 25 ℃

In dark room

TOPCON BM7 + quartz fiber
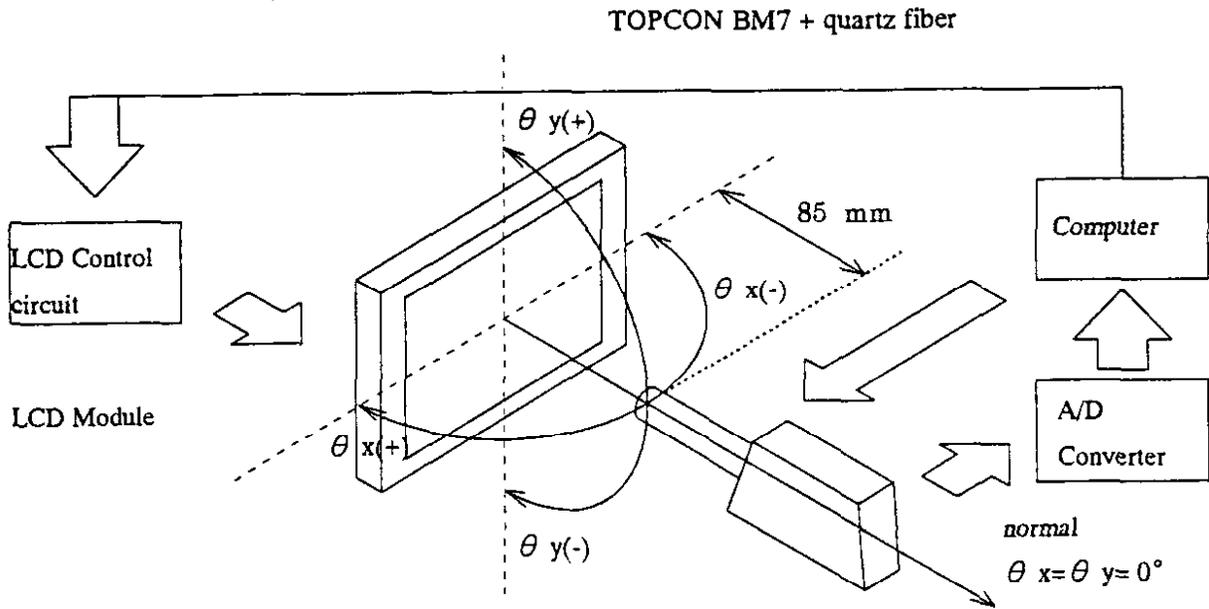
(Measuring spot size : φ 10 mm, Measuring Field : 2 °)

Fig. 8 Optical Characteristics Test Method Ⅱ

[Drive waveform]

1/244 Duty Ratio

Driving voltage

Non-select waveform — Select waveform — Non-select waveform

[Responce waveform]

Photo detector output

100 %

90 %

10 %

$\tau\,r$

$\tau\,d$

$\tau\,r$: Rise time

$\tau\,d$: Decay time

Fig.9 Definition of Response time

SHARP

Fig. 10 Circuit block diagram
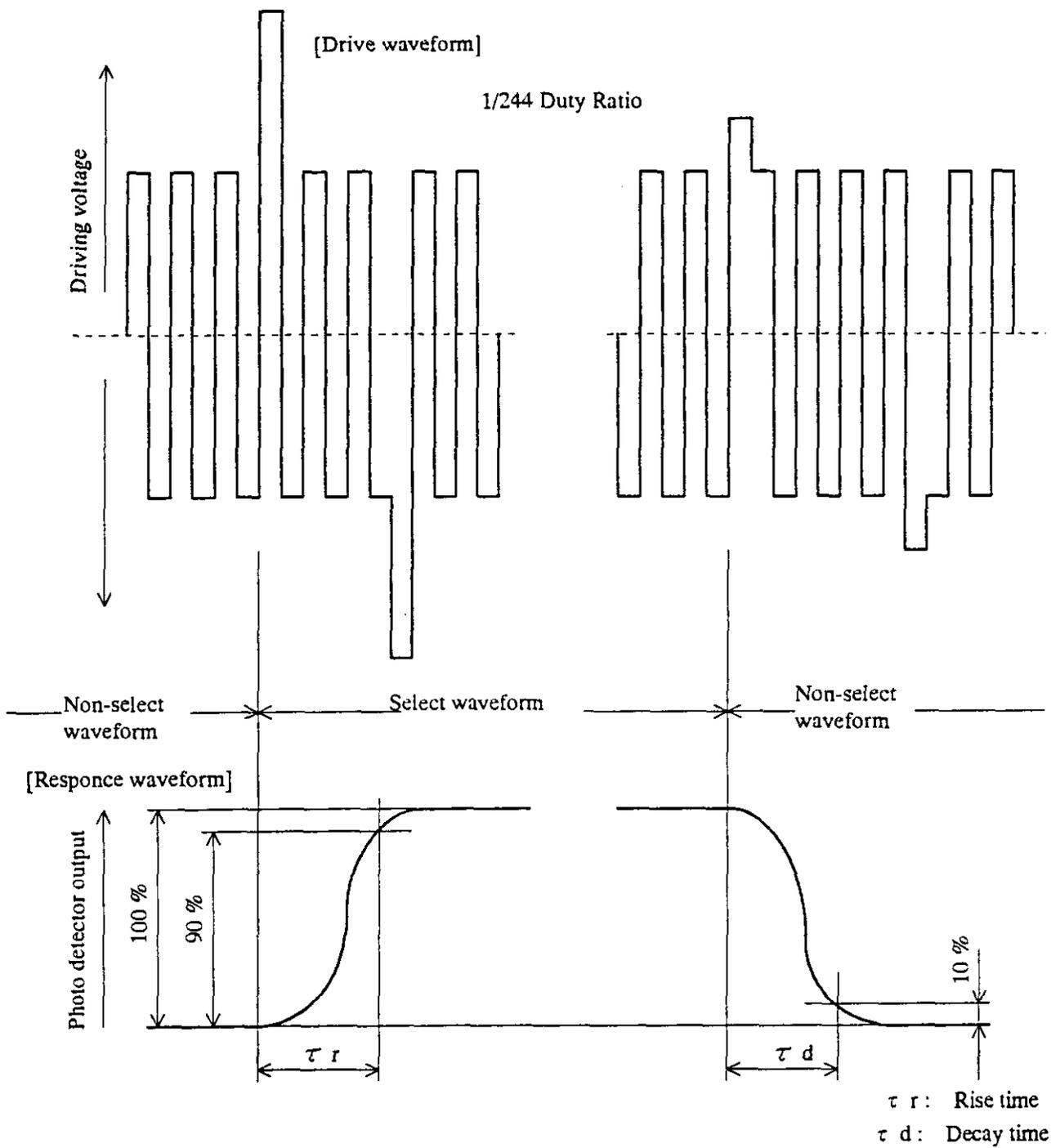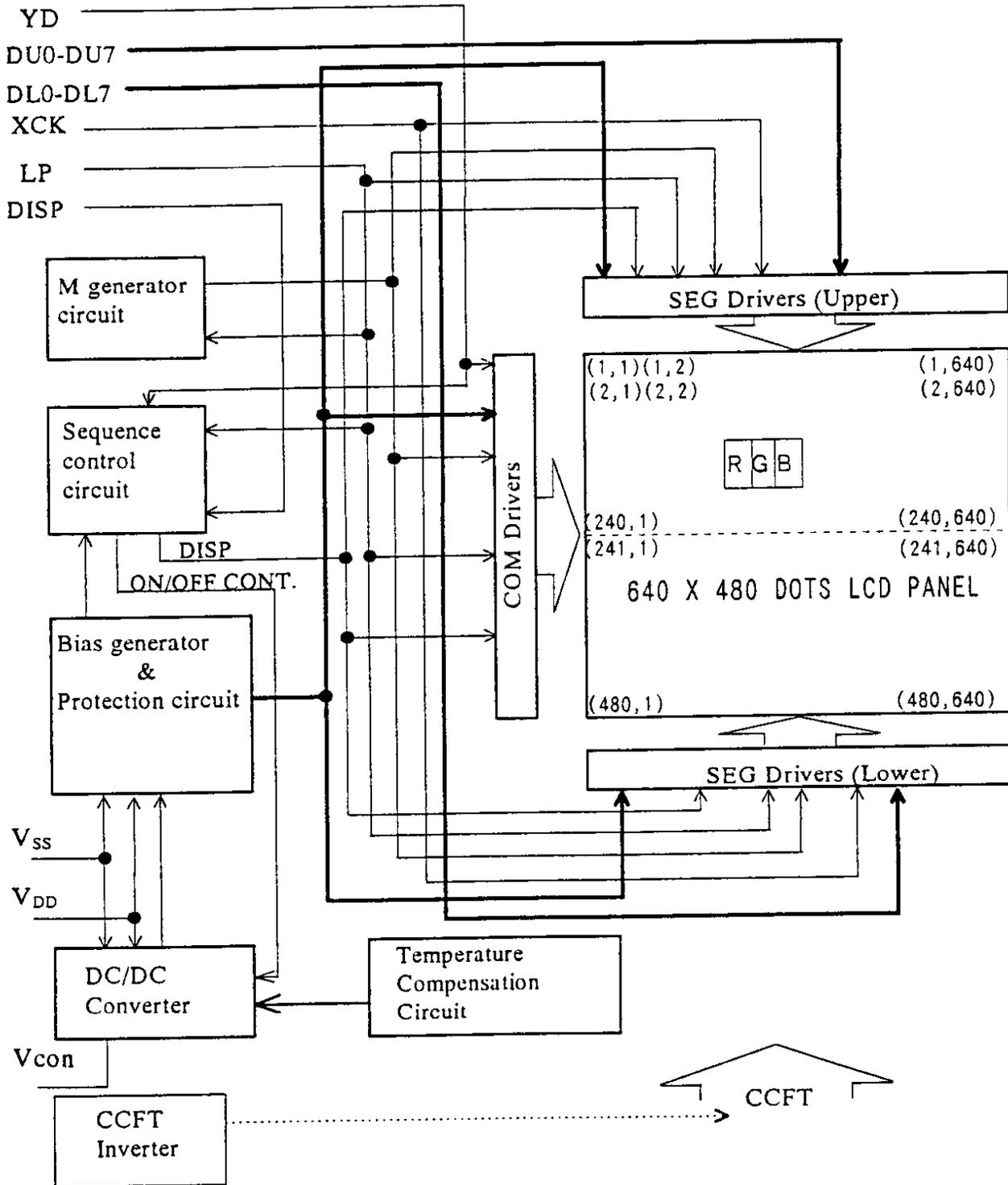
8.Characteristics of Backlight

The ratings are given on condition that the following conditions are satisfied.

1) Rating(Note)   Table9

Parameter	MIN.	TYP.	MAX.	Unit
Brightness	38	55	-	cd/m^2

2) Measurement circuit : CXA-L0505-VJL(TDK)   (at   IL = 3.0 mArms)

3) Measurement equipment :   BM-7 (TOPCON Corporation)

4) Measurement conditions

    4-1.   Measurement circuit voltage :   DC = 12.0 V,   at primary side

    4-2.   LCD: All digits WHITE,   VDD= 3.3 V,   Vcon-VSS = Vmax, DU0-7="H"(White),DL0-7="H"(White)

        Frame Frequency 75 Hz

    4-3.   Ambient temperature :   25 ℃

        Measurement shall be executed 30 minutes after turning on.

5) Used lamp :   K-CA1344SH(WEST ELECTRIC Co.)

   Used cable :   UL3579,AWG#26

           (NISSEI ELECTRIC CO.,LTD or SUMITOMO ELECTRIC INDUSTRIES LTD.)

5-1. Rating (1pc)   Table10

Parameter	Symbol	MIN.	TYP.	MAX.	Unit	Remark
Lamp voltage	V$_L$	-	490	539	Vrms	I$_L$=3mArms
Lamp current	I$_L$	-	3.0	5.0	mArms	*1
Lamp power consumption	P$_L$	-	1.47	-	W	*2
Lamp frequency	F$_L$	30	-	70	kHz	-
Kick-off voltage	V$_s$	-	-	700	Vrms	Ta=25 ℃
		-	-	1050	Vrms	Ta= 0 ℃ *3
Lamp life time	L$_L$	25 000	-	-	h	Ta=25 ℃
	L$_L$	1 000	-	-	h	Ta= 0 ℃ *4

Within no conductor closed. (CCFT only)

*1   It is recommended that IL be not more than 4.0 mArms so that heat radiation of CCFT backlight
    may least affect the display quality.

*2   Power consumption excluded inverter loss.

*3   The circuit voltage(VS) of the inverter should be designed to have some margin. because VS may be
    increased due to the leak current in case of the LCD module.

*4   Average life time of CCFT will be decreased when LCD is operating at lower temperature.

5-2. Operating life

    The *operating life time is 25 000 hours or more at 3.0 mA.*.

    (Operating life with CXA-L0505-VJL or equivalent.)

    The inverter should meet the following conditions to keep the specified life time of used lamp;

    -Since, symmetric waveform without spike in positive and negative

    -Output frequency range: 30 kHz-70 kHz

    Make sure the operating conditions by executing the burn-in enough time.

  The operating life time is defined as having ended when any of the following conditions occur; $25 \pm 1°C$

    -When the voltage required for initial discharge has reached 110 % of the initials value.

    -When the illuminence quantity of light has decreased to 50 % of the initials value.

(NOTE) Rating are defined as the average brightness inside the viewing area specified in Fig.11.
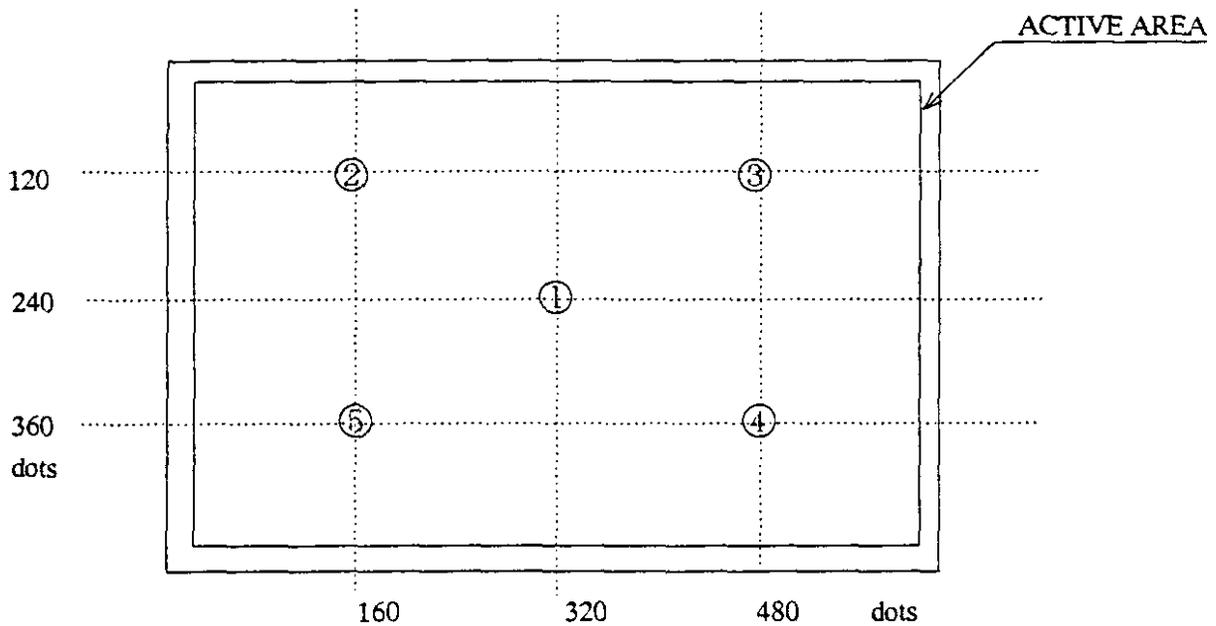

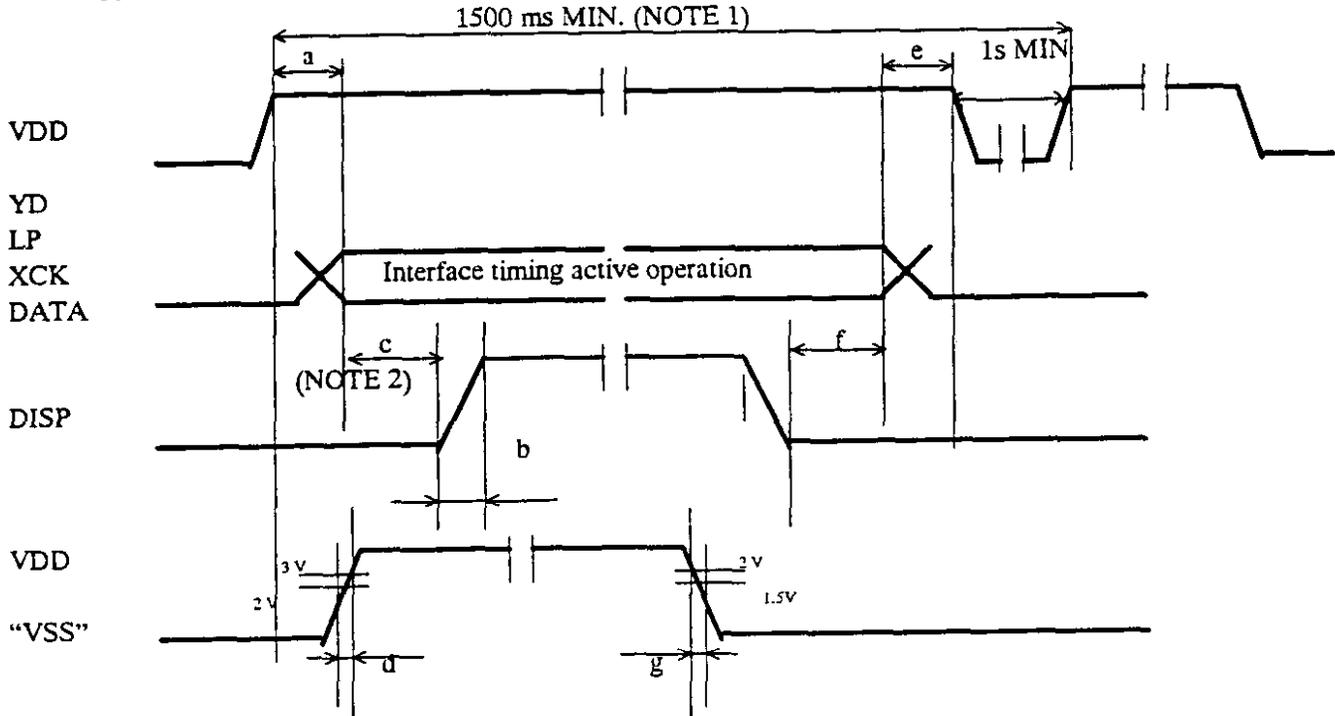Fig.11 Measuring points (1-5)

9.Supply voltage sequence condition

Fig.12 Supply voltage sequence condition

(NOTE 1)   Power ON/OFF cycle time. All signals and power line shall be in accordance with above sequence in case of power ON/OFF.

(NOTE 2)   Before DISP rise up, the signals of YD,LP,XCK,DATA must be input, and the above condition of "a" must be satisfied. The signals which comply with the interface timing in Fig.3,Fig.4, and table 6, must be input.

POWER ON		
Symbol	Allowable value	
a	0 ms MIN.	1 s MAX.
b	—	100 ns MAX.
c	50 ms MIN.	-
d	-	10 ms MAX.

POWER OFF		
Symbol	Allowable value	
e	0 ms MIN.	1 s MAX.
f	0 ms MIN.	1 s MAX.
g	10 ms MIN.	—

10.Applicable inspection standard

The LCD module shall meet the following inspection standard : S-U-037

11.Lot Number

Lot number is shown at the position mentioned in Fig.13 in accordance with the following numbering rule.
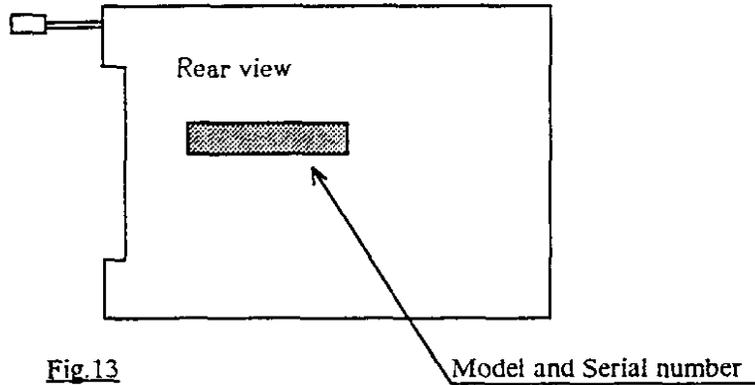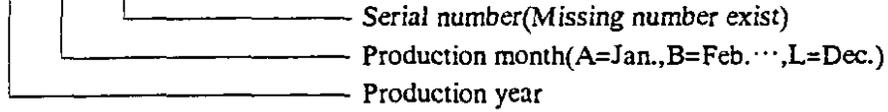
(Example) 98 A 00001

———————————— Serial number(Missing number exist)

———————————— Production month(A=Jan.,B=Feb.···,L=Dec.)

———————————— Production year

Rear view

Fig.13   Model and Serial number

12.Touch Panel Specifications

12.1. Rating
12.1.1. Maximum voltage and current: 7V 24mA

12.1.2. Operating temperature: -10℃～50℃(Humidity from 20% to 90%, No dew condensation)

12.1.3. Storage temperature: -40℃～70℃(Humidity from 20% to 90%, No dew condensation)

12.2. Electrical Performance
12.2.1. Resistance between terminals:

Direction "X"(Film side) : 350～900 Ω(TYP. 480 Ω)

Direction "Y"(Glass side): 450～1100 Ω(TYP. 630 Ω)

12.2.2 Linearity

Direction "X": 1.5% or less

Direction "Y": 1.5% or less

12.2.3. Insulation resistance: DC 25V and 20M Ω or more

12.2.4. Chattering: 10msec or less

12.3. Mechanical Performance
12.3.1. Input: finger or special stylus pen

12.3.2. Activation Force:

Input with finger: 80g or less (typ.15g)

Input with stylus: 80g or less (typ.15g)

12.3.3. Surface hardness: Hardness of pencil 3H or more

12.4. Optical Performance
12.4.1. Optical clarity: 77%(MIN.) 79%(TYP.)

12.5. Correspondable connector
04FFS-SP-TF(JST: SMT,Non-ZIF type) or equivalent

Fig.14 Outline Dimensions

SHARP

SPEC No. LC98312
MODEL No. LM8V311
PAGE 28

名 称 NAME	LCD MODULE
	OUTLINE DIMENSIONS
図番 SYMBOL	640×RGB×480 P0.246
	LM8V311

SHARP CORPORATION

INTERFACE CONNECTOR
① CN1:53261-1510(MOLEX)
<PIN LAYOUT>

PIN	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
	YD	VSS	DISP	UP	VSS	XGT	YSS	DU0	DU1	DU2	DU3	DU4	DU5	DU6	DU7

② CN2:53261-1410(MOLEX)
<PIN LAYOUT>

PIN	1	2	3	4	5	6	7	8	9	10	11	12	13	14
	DL0	DL1	DL2	DL3	DL4	DL5	DL6	DL7	VDD	VSS	VSS	NC	NC	VCOM

③ CCFT CONNECTOR
QZ-19-3F01(HONDA)
<PIN LAYOUT>

PIN	1	2	3
	GND	NC	HV

BEZEL/DISPLAY POSITION

1) TOLERANCE X-DIRECTION
2) TOLERANCE Y-DIRECTION
3) OBLIQUITY OF DISPLAY AREA

A :2.5±0.8
AA:1.5±0.5
B :2.5±0.8
BB:1.5±0.5
IC-D|<0.8 ±0.5

DRAWING No. 1998. 3. 26.